

### Low switching losses IGBT in Highspeed3 technology co-packed with soft, fast recovery full current rated antiparallel emitter controlled diode

#### Features

- $V_{CE} = 1200\text{ V}$
- $I_C = 40\text{ A}$
- Ultra-low loss switching losses due to Kelvin emitter pin package in combination with Highspeed3 technology
- High efficiency in hard switching and resonant topologies
- 10  $\mu\text{sec}$  short circuit withstand time at  $T_{vj} = 175^\circ\text{C}$
- Easy parallel switching capability due to positive temperature coefficient in  $V_{CEsat}$
- Low EMI
- Low gate charge  $Q_G$
- Very soft, fast recovery full current antiparallel diode
- Maximum junction temperature  $T_{vjmax} = 175^\circ\text{C}$
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

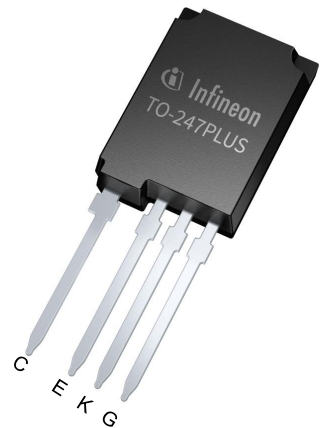
#### Potential applications

- Industrial UPS
- Charger
- Energy storage
- Three-level solar string inverter

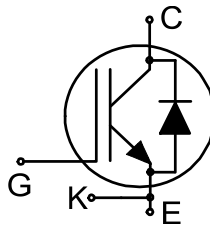
#### Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

#### Description



- Halogen-free
- Lead-free
- Green
- RoHS



Type	Package	Marking
IKY40N120CH3	PG-TO247-4-2	K40MCH3

## Table of contents

	<b>Description</b> .....	1
	<b>Features</b> .....	1
	<b>Potential applications</b> .....	1
	<b>Product validation</b> .....	1
	<b>Table of contents</b> .....	2
<b>1</b>	<b>Package</b> .....	3
<b>2</b>	<b>IGBT</b> .....	3
<b>3</b>	<b>Diode</b> .....	5
<b>4</b>	<b>Characteristics diagrams</b> .....	7
<b>5</b>	<b>Package outlines</b> .....	14
<b>6</b>	<b>Testing conditions</b> .....	15
	<b>Revision history</b> .....	16
	<b>Disclaimer</b> .....	17

## 1 Package

**Table 1** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Storage temperature	$T_{stg}$		-55		150	°C
Soldering temperature	$T_{sold}$	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W
IGBT thermal resistance, junction-case	$R_{th(j-c)}$				0.3	K/W
Diode thermal resistance, junction-case	$R_{th(j-c)}$				0.5	K/W

## 2 IGBT

**Table 2** Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit	
Collector-emitter voltage	$V_{CE}$	$T_{vj} \geq 25\text{ °C}$	1200	V	
DC collector current, limited by $T_{vjmax}$	$I_C$	limited by bondwire	$T_c = 25\text{ °C}$	80	A
			$T_c = 134\text{ °C}$	40	
Pulsed collector current, $t_p$ limited by $T_{vjmax}$	$I_{Cpulse}$		160	A	
Turn-off safe operating area		$V_{CE} \leq 1200\text{ V}$ , $t_p = 1\text{ }\mu\text{s}$ , $T_{vj} \leq 175\text{ °C}$	160	A	
Gate-emitter voltage	$V_{GE}$		$\pm 20$	V	
Transient gate-emitter voltage	$V_{GE}$	$t_p \leq 10\text{ }\mu\text{s}$ , $D < 0.01$	$\pm 30$	V	
Short-circuit withstand time	$t_{SC}$	$V_{CC} \leq 600\text{ V}$ , $V_{GE} = 15\text{ V}$ , Allowed number of short circuits < 1000, Time between short circuits $\geq 1.0\text{ s}$ , $T_{vj} = 175\text{ °C}$	10	$\mu\text{s}$	
Power dissipation	$P_{tot}$	$T_c = 25\text{ °C}$	500	W	
		$T_c = 134\text{ °C}$	136		

**Table 3** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter breakdown voltage	$V_{BRCES}$	$I_C = 0.5\text{ mA}$ , $V_{GE} = 0\text{ V}$	1200			V

(table continues...)

**Table 3 (continued) Characteristic values**

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CEsat}$	$I_C = 40\text{ A}, V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$		2	2.35	V
			$T_{vj} = 175\text{ °C}$		2.5		
Gate-emitter threshold voltage	$V_{GETh}$	$I_C = 1.5\text{ mA}, V_{CE} = V_{GE}$		5.1	5.8	6.5	V
Zero gate-voltage collector current	$I_{CES}$	$V_{CE} = 1200\text{ V}, V_{GE} = 0\text{ V}$	$T_{vj} = 25\text{ °C}$			250	$\mu\text{A}$
			$T_{vj} = 175\text{ °C}$		3000		
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}$				100	nA
Transconductance	$g_{fs}$	$I_C = 40\text{ A}, V_{CE} = 20\text{ V}$			14		S
Input capacitance	$C_{ies}$	$V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1000\text{ kHz}$			2385		pF
Output capacitance	$C_{oes}$	$V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1000\text{ kHz}$			235		pF
Reverse transfer capacitance	$C_{res}$	$V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1000\text{ kHz}$			132		pF
Gate charge	$Q_G$	$I_C = 40\text{ A}, V_{GE} = 15\text{ V}, V_{CC} = 960\text{ V}$			190		nC
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 12\ \Omega, R_{G(off)} = 12\ \Omega, L_\sigma = 70\text{ nH}, C_\sigma = 67\text{ pF}$	$T_{vj} = 25\text{ °C}, I_C = 40\text{ A}$		30		ns
			$T_{vj} = 175\text{ °C}, I_C = 40\text{ A}$		29		
Rise time (inductive load)	$t_r$	$V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 12\ \Omega, R_{G(off)} = 12\ \Omega, L_\sigma = 70\text{ nH}, C_\sigma = 67\text{ pF}$	$T_{vj} = 25\text{ °C}, I_C = 40\text{ A}$		29		ns
			$T_{vj} = 175\text{ °C}, I_C = 40\text{ A}$		32		
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 12\ \Omega, R_{G(off)} = 12\ \Omega, L_\sigma = 70\text{ nH}, C_\sigma = 67\text{ pF}$	$T_{vj} = 25\text{ °C}, I_C = 40\text{ A}$		280		ns
			$T_{vj} = 175\text{ °C}, I_C = 40\text{ A}$		375		
Fall time (inductive load)	$t_f$	$V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 12\ \Omega, R_{G(off)} = 12\ \Omega, L_\sigma = 70\text{ nH}, C_\sigma = 67\text{ pF}$	$T_{vj} = 25\text{ °C}, I_C = 40\text{ A}$		26		ns
			$T_{vj} = 175\text{ °C}, I_C = 40\text{ A}$		64		
Turn-on energy	$E_{on}$	$V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 12\ \Omega, R_{G(off)} = 12\ \Omega, L_\sigma = 70\text{ nH}, C_\sigma = 67\text{ pF}$	$T_{vj} = 25\text{ °C}, I_C = 40\text{ A}$		2.2		mJ
			$T_{vj} = 175\text{ °C}, I_C = 40\text{ A}$		3.1		

**(table continues...)**

**Table 3 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Turn-off energy	$E_{off}$	$V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V},$ $R_{G(on)} = 12\ \Omega,$ $R_{G(off)} = 12\ \Omega, L_{\sigma} = 70\text{ nH},$ $C_{\sigma} = 67\text{ pF}$	$T_{vj} = 25\ ^\circ\text{C},$ $I_C = 40\text{ A}$		1.3		mJ
			$T_{vj} = 175\ ^\circ\text{C},$ $I_C = 40\text{ A}$		2.5		
Total switching energy	$E_{ts}$	$V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V},$ $R_{G(on)} = 12\ \Omega,$ $R_{G(off)} = 12\ \Omega, L_{\sigma} = 70\text{ nH},$ $C_{\sigma} = 67\text{ pF}$	$T_{vj} = 25\ ^\circ\text{C},$ $I_C = 40\text{ A}$		3.5		mJ
			$T_{vj} = 175\ ^\circ\text{C},$ $I_C = 40\text{ A}$		5.6		
Operating junction temperature	$T_{vj}$		-40		175	$^\circ\text{C}$	

### 3 Diode

**Table 4 Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	$V_{RRM}$	$T_{vj} \geq 25\ ^\circ\text{C}$	1200	V	
Diode forward current, limited by $T_{vjmax}$	$I_F$		$T_C = 25\ ^\circ\text{C}$	80	A
			$T_C = 100\ ^\circ\text{C}$	40	
Diode pulsed current, $t_p$ limited by $T_{vjmax}$	$I_{Fpulse}$		160	A	

**Table 5 Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Diode forward voltage	$V_F$	$I_F = 40\text{ A}$	$T_{vj} = 25\ ^\circ\text{C}$		1.9	2.3	V
			$T_{vj} = 175\ ^\circ\text{C}$		1.85		
Diode reverse recovery time	$t_{rr}$	$V_R = 600\text{ V}$	$T_{vj} = 25\ ^\circ\text{C},$ $I_F = 40\text{ A},$ $-di_F/dt = 600\text{ A}/\mu\text{s}$		350		ns
			$T_{vj} = 175\ ^\circ\text{C},$ $I_F = 40\text{ A},$ $-di_F/dt = 600\text{ A}/\mu\text{s}$		550		

(table continues...)

**Table 5 (continued) Characteristic values**

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode reverse recovery charge	$Q_{rr}$	$V_R = 600\text{ V}$	$T_{vj} = 25\text{ °C},$ $I_F = 40\text{ A},$ $-di_F/dt = 600\text{ A}/\mu\text{s}$		3		$\mu\text{C}$
					7.5		
Diode peak reverse recovery current	$I_{rrm}$	$V_R = 600\text{ V}$	$T_{vj} = 25\text{ °C},$ $I_F = 40\text{ A},$ $-di_F/dt = 600\text{ A}/\mu\text{s}$		22		A
					30		
Diode peak rate of fall of reverse recovery current	$di_{rr}/dt$	$V_R = 600\text{ V}$	$T_{vj} = 25\text{ °C},$ $I_F = 40\text{ A},$ $-di_F/dt = 600\text{ A}/\mu\text{s}$		188		$\text{A}/\mu\text{s}$
					142		
Operating junction temperature	$T_{vj}$			-40		175	$^{\circ}\text{C}$

**Note:** For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Electrical Characteristic at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified.

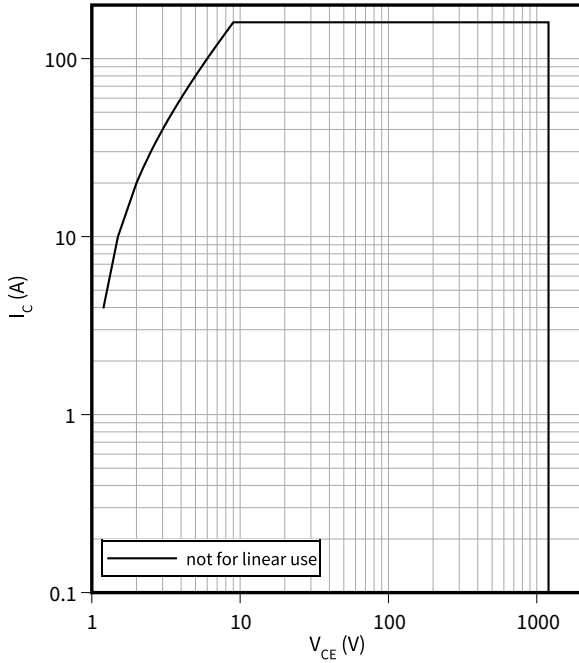
Dynamic test circuit, parasitic inductance  $L_{\sigma}$ , parasitic capacitor  $C_{\sigma}$  from Fig. E. Energy losses include “tail” and diode reverse recovery.

## 4 Characteristics diagrams

### Forward bias safe operating area

$$I_C = f(V_{CE})$$

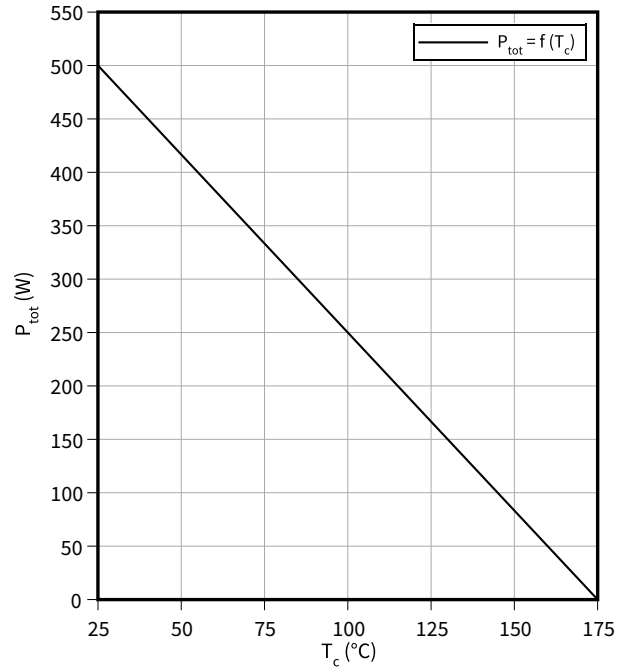
$$D = 0, T_{vj} \leq 175\text{ °C}, V_{GE} = 15\text{ V}, T_c = 25\text{ °C}$$



### Power dissipation as a function of case temperature

$$P_{tot} = f(T_c)$$

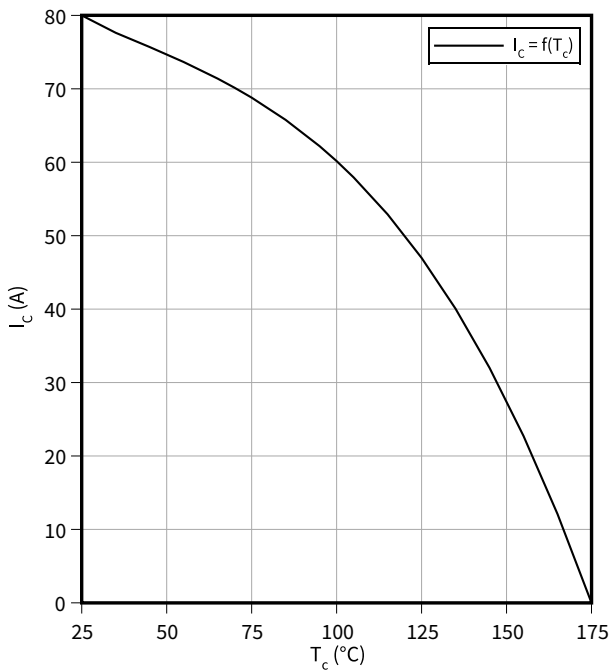
$$T_{vj} \leq 175\text{ °C}$$



### Collector current as a function of case temperature

$$I_C = f(T_c)$$

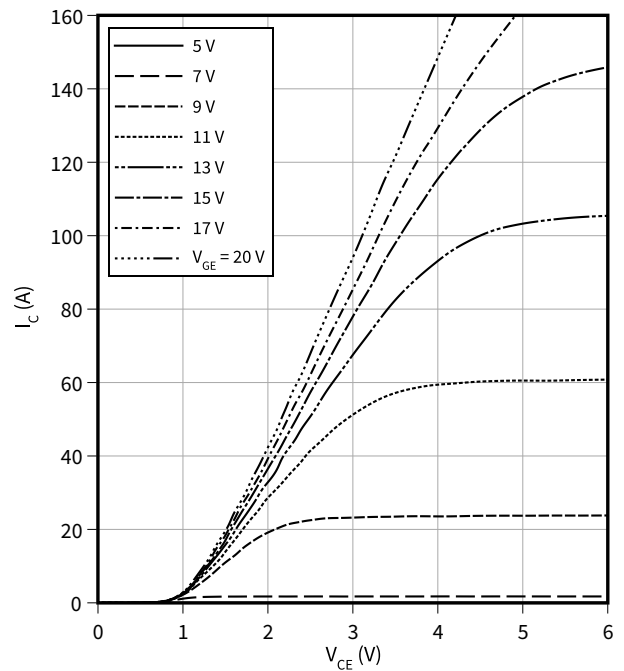
$$T_{vj} \leq 175\text{ °C}, V_{GE} \geq 15\text{ V}$$



### Typical output characteristic

$$I_C = f(V_{CE})$$

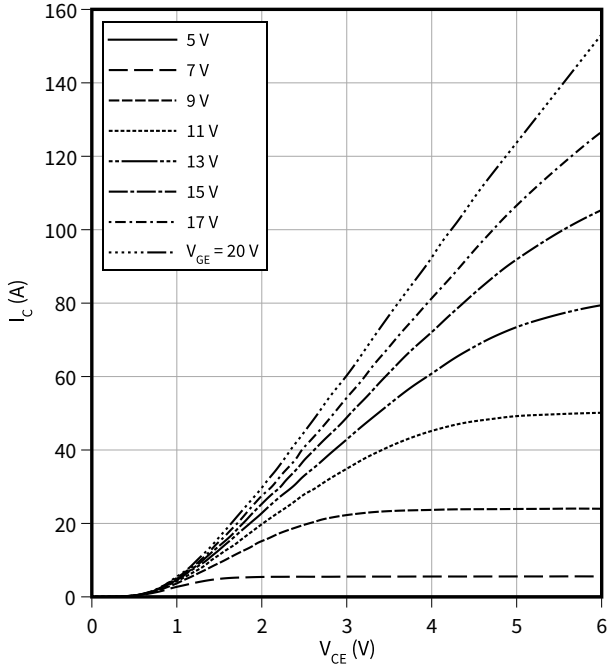
$$T_{vj} = 25\text{ °C}$$



4 Characteristics diagrams

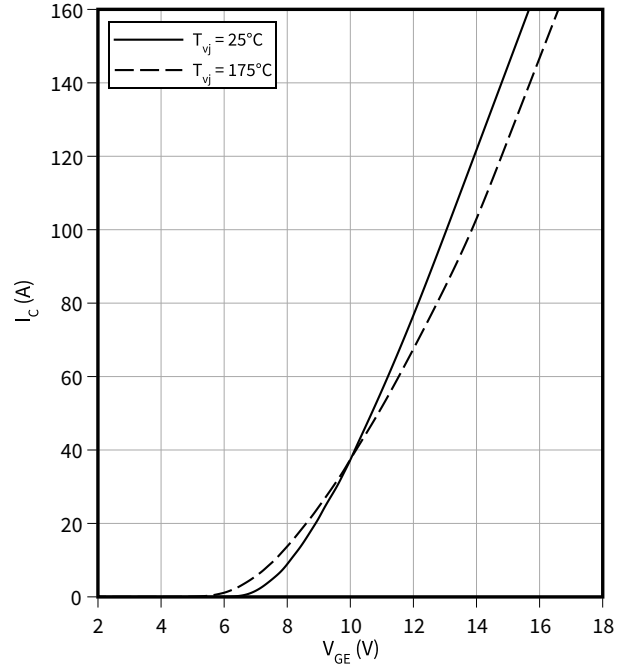
**Typical output characteristic**

$I_C = f(V_{CE})$   
 $T_{vj} = 175\text{ °C}$



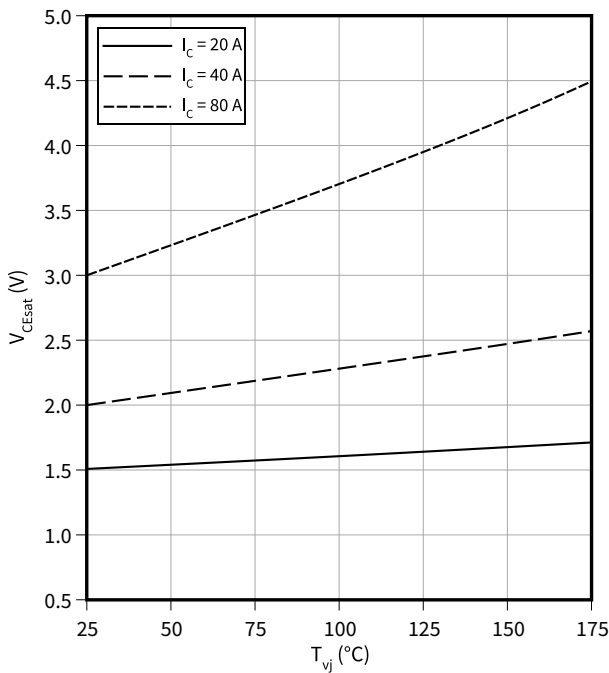
**Typical transfer characteristic**

$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



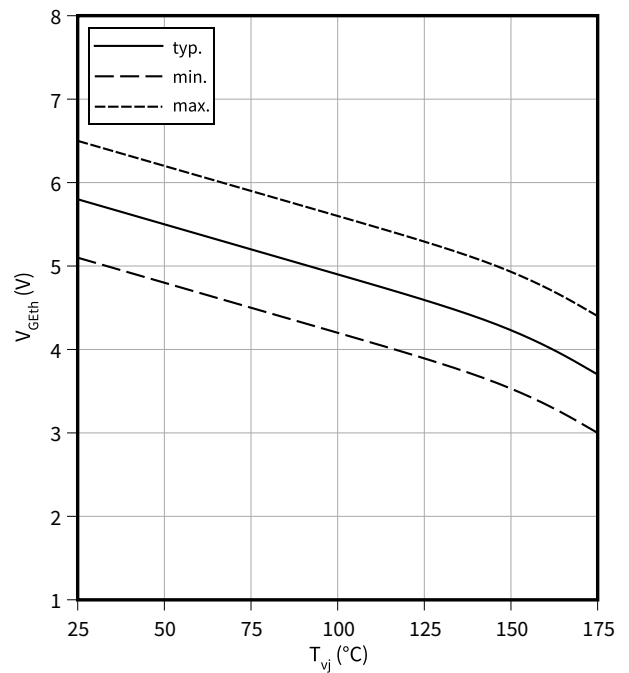
**Typical collector-emitter saturation voltage as a function of junction temperature**

$V_{CEsat} = f(T_{vj})$   
 $V_{GE} = 15\text{ V}$



**Gate-emitter threshold voltage as a function of junction temperature**

$V_{GEth} = f(T_{vj})$   
 $I_C = 1.5\text{ mA}$

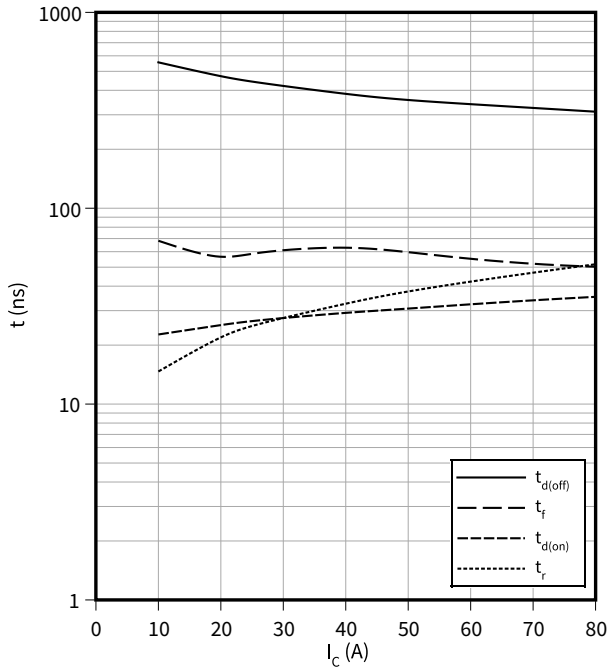




**Typical switching times as a function of collector current**

$t = f(I_C)$

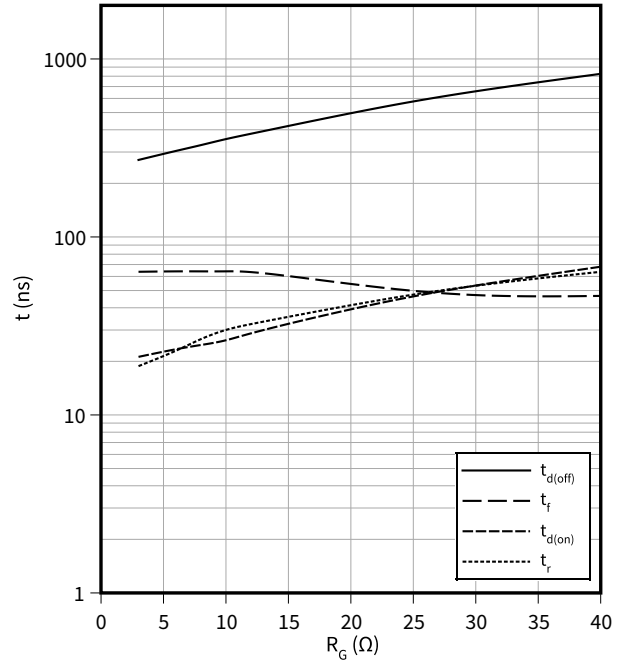
$V_{CC} = 600\text{ V}, T_{vj} = 175\text{ }^\circ\text{C}, V_{GE} = 0/15\text{ V}, R_G = 12\text{ }\Omega$



**Typical switching times as a function of gate resistor**

$t = f(R_G)$

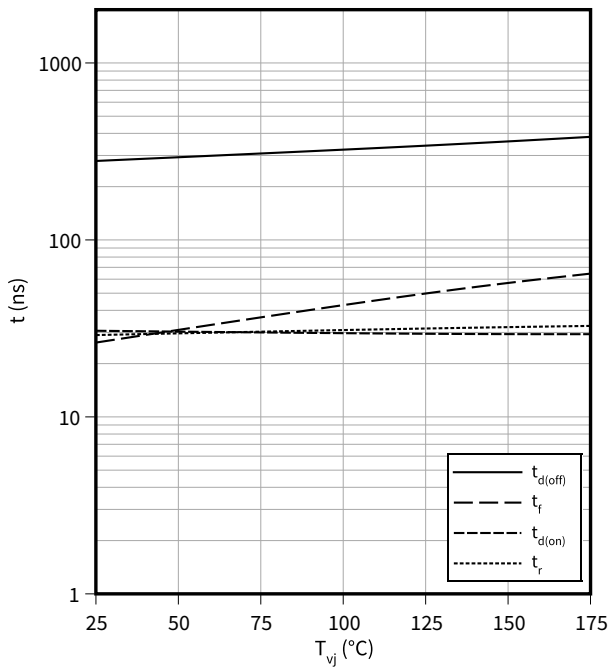
$I_C = 40\text{ A}, V_{CC} = 600\text{ V}, T_{vj} = 175\text{ }^\circ\text{C}, V_{GE} = 0/15\text{ V}$



**Typical switching times as a function of junction temperature**

$t = f(T_{vj})$

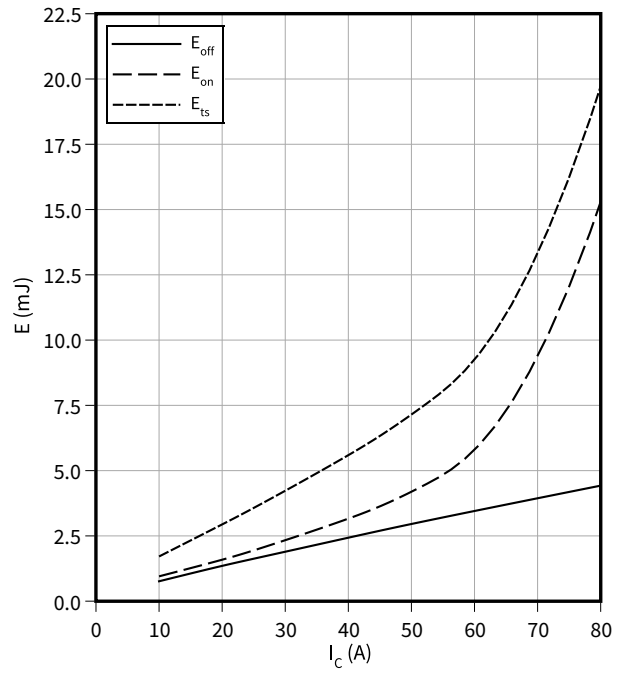
$I_C = 40\text{ A}, V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_G = 12\text{ }\Omega$



**Typical switching energy losses as a function of collector current**

$E = f(I_C)$

$V_{CC} = 600\text{ V}, T_{vj} = 175\text{ }^\circ\text{C}, V_{GE} = 0/15\text{ V}, R_G = 12\text{ }\Omega$

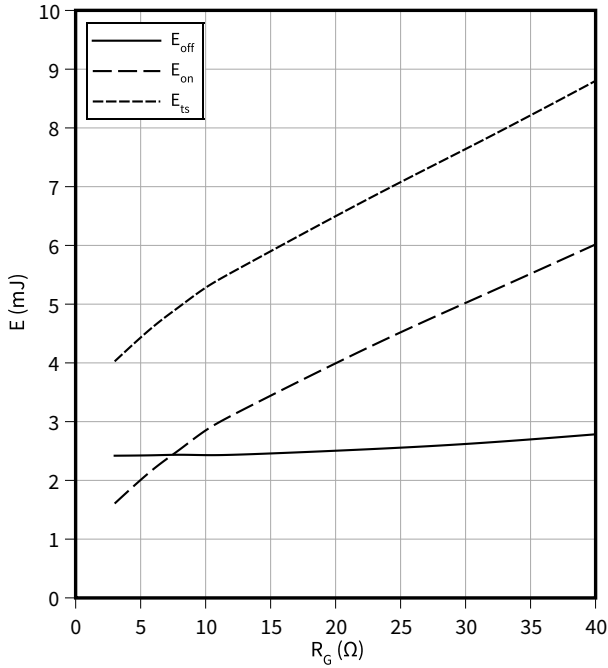


4 Characteristics diagrams

**Typical switching energy losses as a function of gate resistor**

$E = f(R_G)$

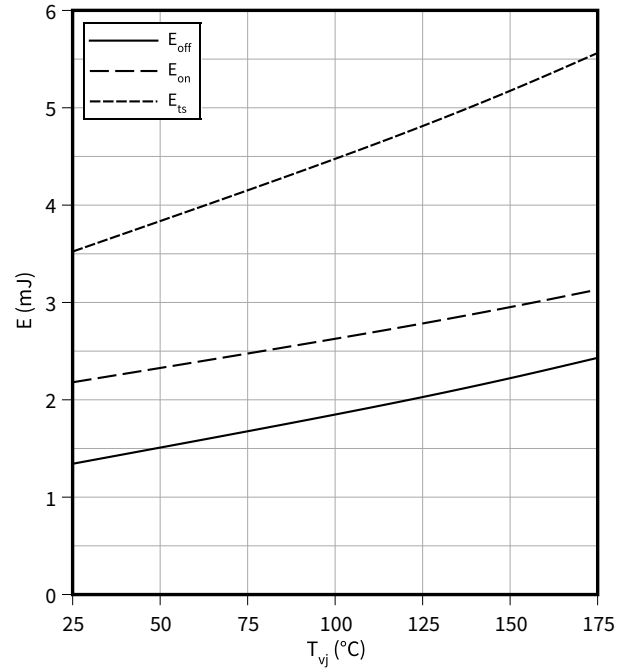
$I_C = 40\text{ A}, V_{CC} = 600\text{ V}, T_{vj} = 175\text{ }^\circ\text{C}, V_{GE} = 0/15\text{ V}$



**Typical switching energy losses as a function of junction temperature**

$E = f(T_{vj})$

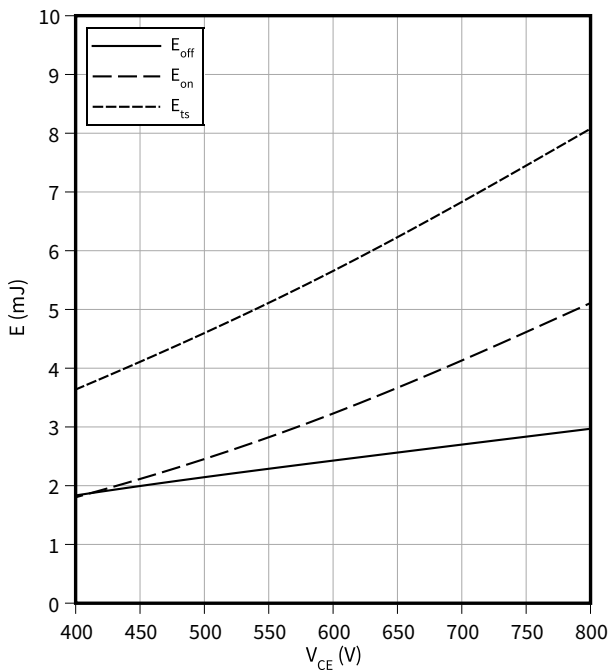
$I_C = 40\text{ A}, V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_G = 12\text{ }^\circ\Omega$



**Typical switching energy losses as a function of collector emitter voltage**

$E = f(V_{CE})$

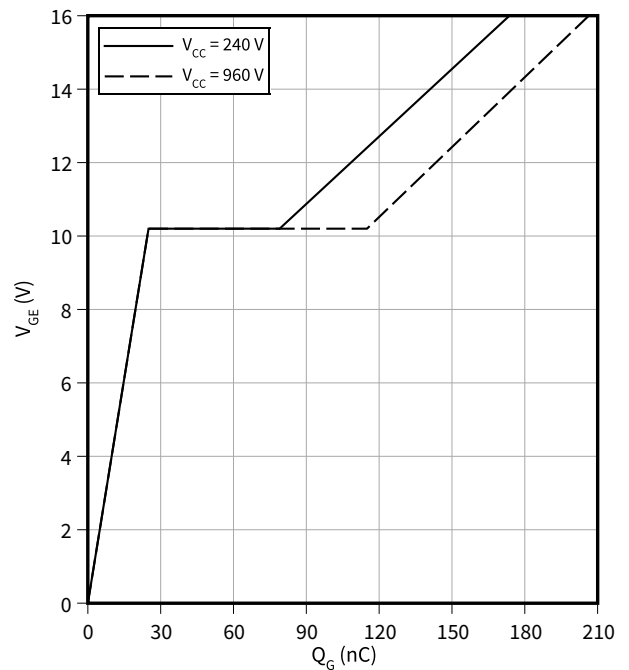
$I_C = 40\text{ A}, T_{vj} = 175\text{ }^\circ\text{C}, V_{GE} = 0/15\text{ V}, R_G = 12\text{ }^\circ\Omega$



**Typical gate charge**

$V_{GE} = f(Q_G)$

$I_C = 40\text{ A}$

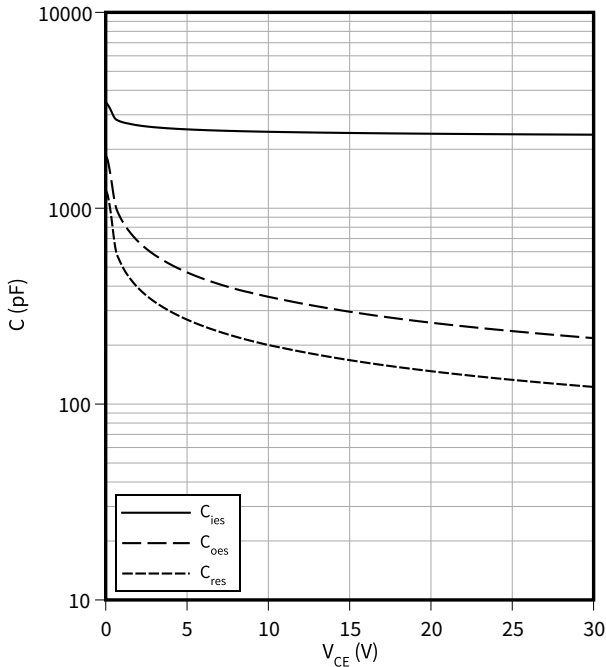


4 Characteristics diagrams

**Typical capacitance as a function of collector-emitter voltage**

$C = f(V_{CE})$

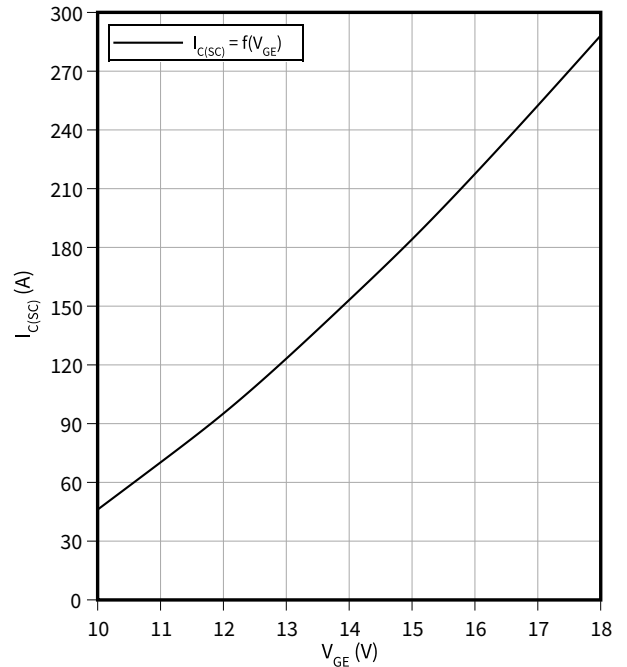
$f = 1000 \text{ kHz}, V_{GE} = 0 \text{ V}$



**Typical short circuit collector current as a function of gate-emitter voltage**

$I_{C(SC)} = f(V_{GE})$

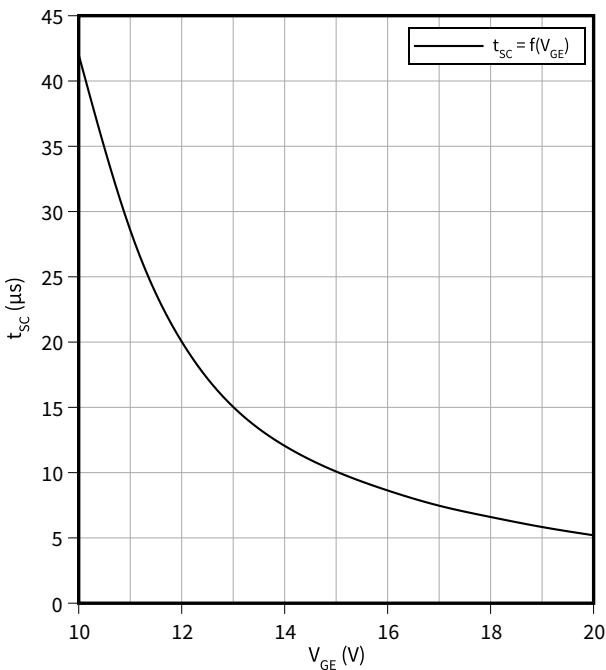
$T_{vj} \leq 175 \text{ }^\circ\text{C}, V_{CC} \leq 600 \text{ V}$



**Short circuit withstand time as a function of gate-emitter voltage**

$t_{SC} = f(V_{GE})$

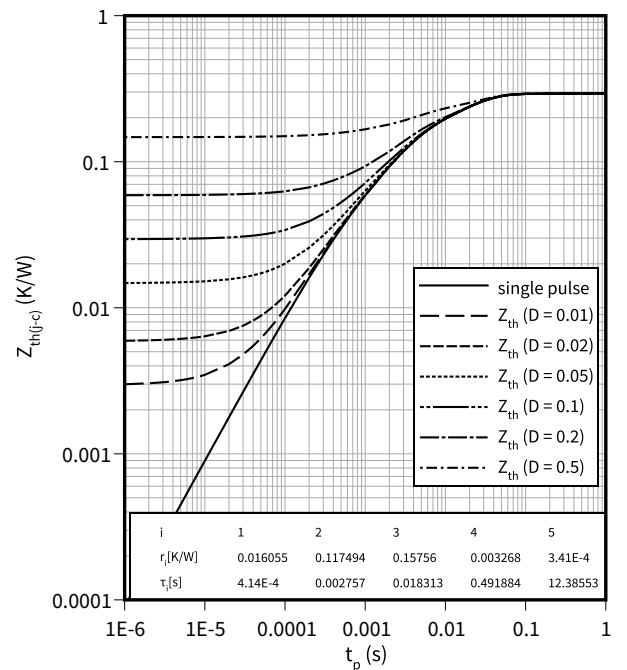
$T_{vj} \leq 175 \text{ }^\circ\text{C}, V_{CC} \leq 600 \text{ V}$



**IGBT transient thermal impedance as a function of pulse width**

$Z_{th(j-c)} = f(t_p)$

$D = t_p/T$

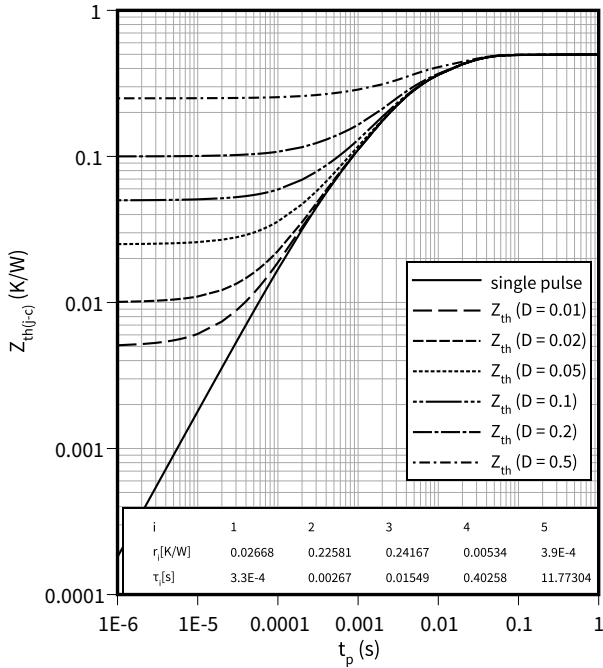


4 Characteristics diagrams

**Diode transient thermal impedance as a function of pulse width**

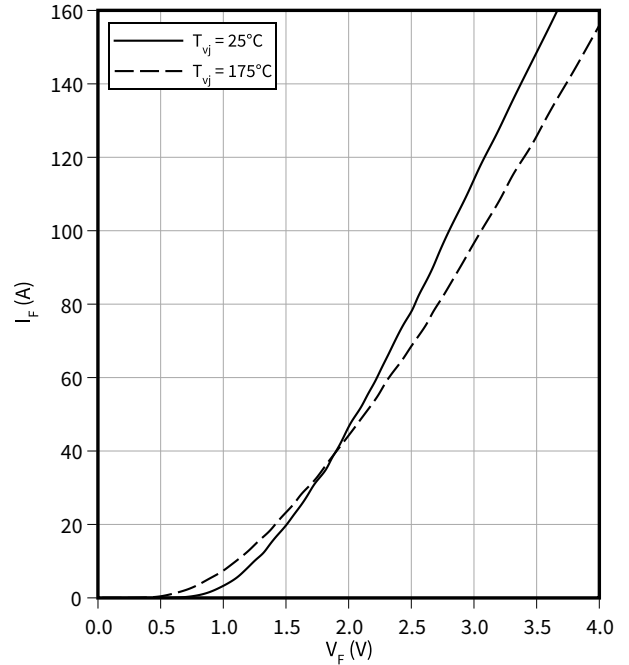
$$Z_{th(j-c)} = f(t_p)$$

$$D = t_p/T$$



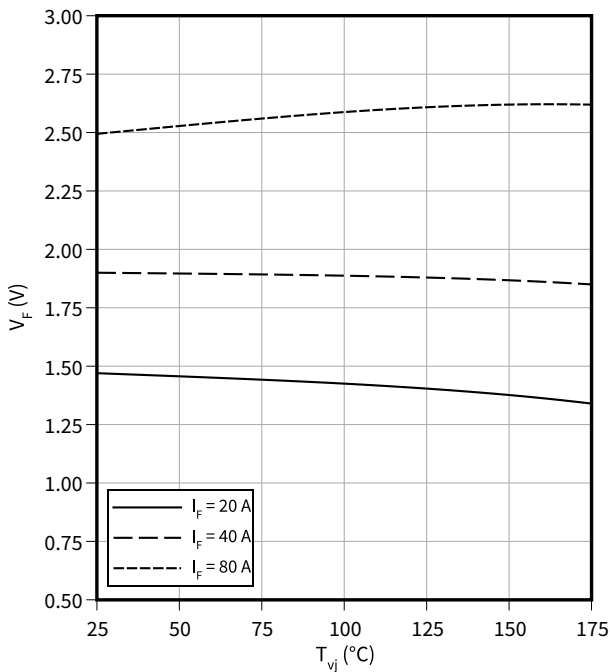
**Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$



**Typical diode forward voltage as a function of junction temperature**

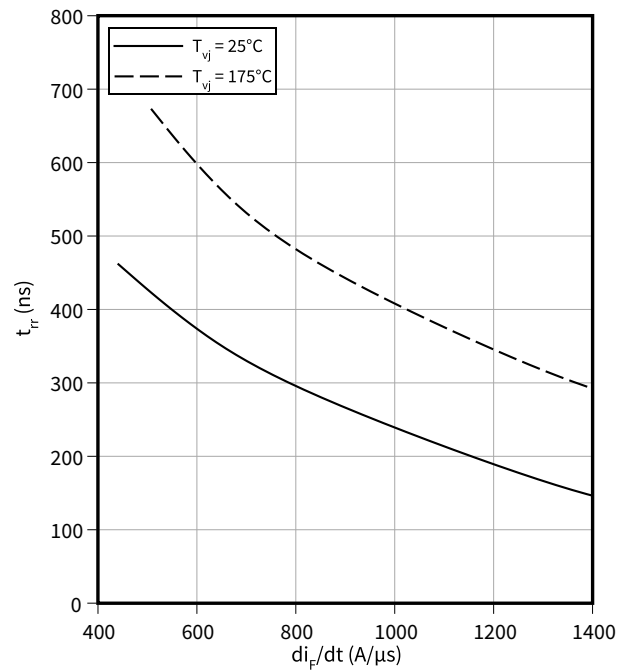
$$V_F = f(T_{vj})$$



**Typical reverse recovery time as a function of diode current slope**

$$t_{rr} = f(di_F/dt)$$

$$V_R = 600 \text{ V}, I_F = 40 \text{ A}$$

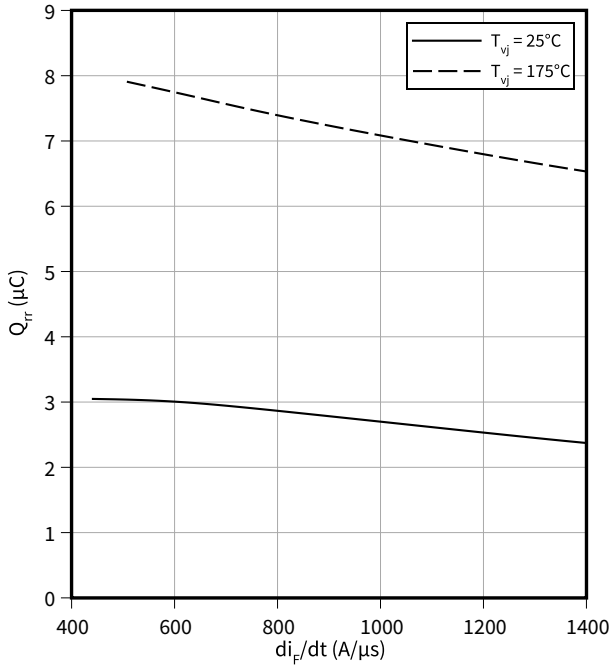


4 Characteristics diagrams

**Typical reverse recovery charge as a function of diode current slope**

$Q_{rr} = f(di_F/dt)$

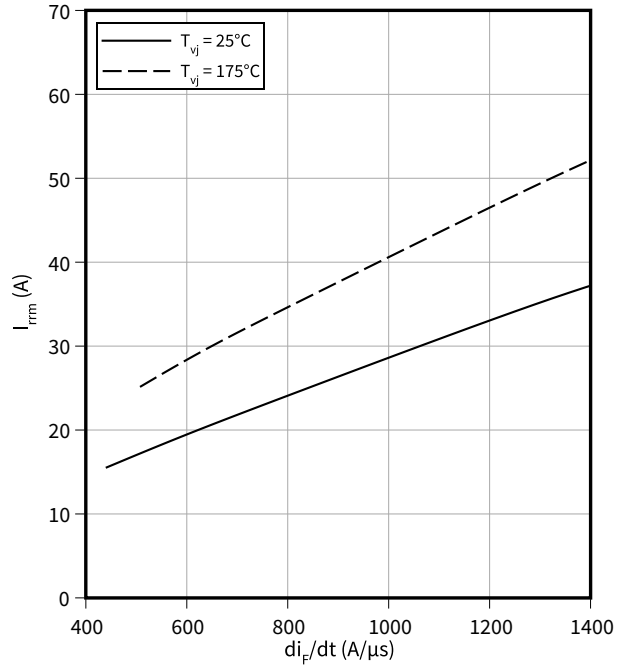
$V_R = 600\text{ V}, I_F = 40\text{ A}$



**Typical reverse recovery current as a function of diode current slope**

$I_{rrm} = f(di_F/dt)$

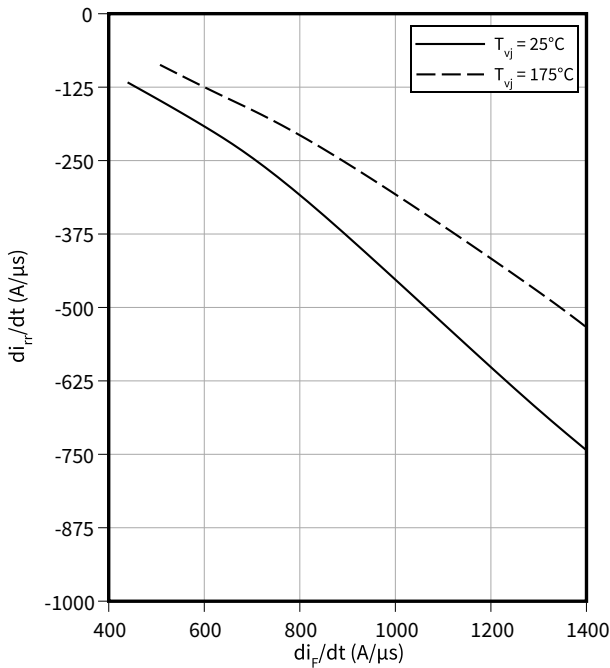
$V_R = 600\text{ V}, I_F = 40\text{ A}$



**Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**

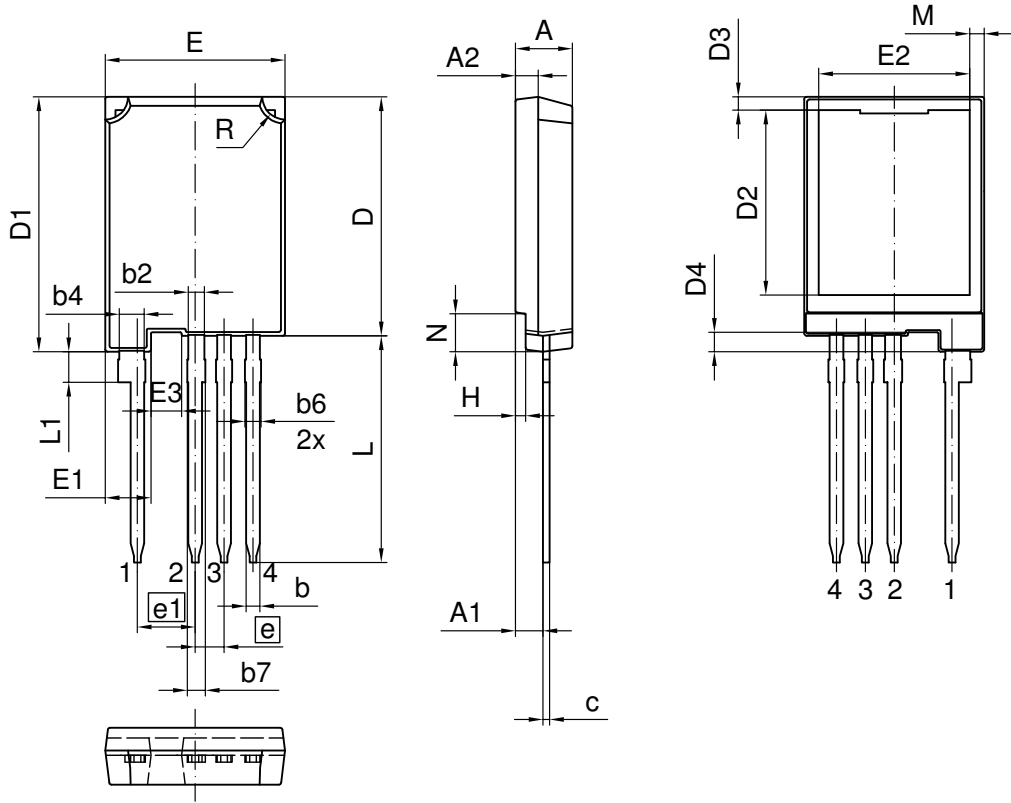
$di_{rr}/dt = f(di_F/dt)$

$V_R = 600\text{ V}, I_F = 40\text{ A}$



**5 Package outlines**

**PG-TO247-4-2**



**NOTES:**

PACKAGE SURFACE ROUTE BETWEEN PIN 1 & PIN 2 WILL BE 5.1mm MIN.

ALL b... AND c DIMENSIONS INCLUDING PLATING EXCEPT AREA OF CUTTING

DIMENSION	MILLIMETERS	
	MIN.	MAX.
A	4.9	5.1
A1	2.31	2.51
A2	1.9	2.1
b	1.16	1.29
b2	1.36	1.49
b4	2.16	2.29
b6	1.16	1.45
b7	1.16	1.65
c	0.59	0.66
D	20.9	21.1
D1	22.3	22.5
D2	15.95	16.55
D3	1	1.35
D4	1.6	1.8
E	15.7	15.9
E1	3.9	4.1
E2	13.1	13.5
E3	2.58	2.78
e	2.54	
e1	5.08	
H	0.8	1
L	19.8	20.1
L1	2.55	2.85
M	0.97	1.57
N	3.24	3.44
R	1.9	2.1

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**Figure 1**

**6 Testing conditions**



**Figure 2**

## Revision history

Document revision	Date of release	Description of changes
V2.1	2017-04-26	Final data sheet
V2.2	2017-06-09	Update Figure 26
V2.3	2019-04-15	Update condition for V <sub>geth</sub> page 4 and Fig.11
n/a	2020-11-30	Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy
1.10	2023-01-19	Correction of diagram: “Typical switching energy losses as a function of junction temperature”